

Fast Recovery Diodes

Stud Version, 150A

FEATURES

- Alloy diode
- Popular series for rough service
- High voltage ratings up to 1200V
- Stud cathode and stud anode version
- RoHS compliant
- Designed and qualified for industrial level
- Glass passivated chip
- Reverse recovery time (t_{rr}) < 500 nS



TYPICAL APPLICATIONS

DO-205AA(DO-8)

- Welders
- Power supplies
- Motor controls
- Battery chargers
- General industrial current rectification
- Freewheeling diodes
- High power drives
- Fast recovery rectifier applications

PRODUCT SUMMARY	
$I_{F(AV)}$	150A

MAJOR RATINGS AND CHARACTERISTICS			
PARAMETER	TEST CONDITIONS	150FD(R)	UNIT
$I_{F(AV)}$		150	A
	Maximum T_C	125	°C
I_{FSM}	50 HZ	3000	A
	60 HZ	3141	
I^2t	50 HZ	45	kA^2s
	60 HZ	40.9	
V_{RRM}	Range	400 to 1200	V
t_{rr}	$T_j = 25^\circ C$	250 to 500	nS
T_J		-40 to 175	°C

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS				
TYPE NUMBER	VOLTAGE CODE	V_{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V_{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I_{RRM} , MAXIMUM AT $T_J = 175^\circ C$ mA
150FD(R)	04	400	500	15
	06	600	700	
	08	800	900	
	10	1000	1100	
	12	1200	1300	

FORWARD CONDUCTION						
PARAMETER	SYMBOL	TEST CONDITIONS			150D(R)	UNIT
Maximum average forward current at maximum case temperature	$I_{F(AV)}$	180° conduction, half sine wave			150	A
					125	°C
Maximum RMS forward current	$I_{F(RMS)}$	DC at 110°C			235.5	A
Maximum peak, one cycle forward, non-repetitive surge current	I_{FSM}	$t = 10ms$	No voltage reapplied	Sinusoidal half wave, initial $T_J = T_J$ maximum	3000	A
		$t = 8.3ms$			3141	
		$t = 10ms$	100% V_{RRM} reapplied		2519	
		$t = 8.3ms$			2635	
Maximum I^2t for fusing	I^2t	$t = 10ms$	No voltage reapplied		45	kA^2s
		$t = 8.3ms$			40.9	
		$t = 10ms$	100% V_{RRM} reapplied		31.7	
		$t = 8.3ms$			28.8	
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	$t = 0.1 ms$ to 10 ms, no voltage reapplied			450	$kA^2\sqrt{s}$
Maximum value of threshold voltage	$V_{F(TO)}$	$T_J = T_J$ Maximum			0.95	V
Maximum value of forward slope resistance	r_F				1.05	$m\Omega$
Maximum forward voltage drop	V_{FM}	$I_{pk} = 470A$, $T_J = 25^\circ C$, $t_p = 10ms$ sinusoidal wave			1.65	V

SWITCHING					
PARAMETER	SYMBOL	TEST CONDITIONS		150FD(R)	UNIT
		04 to 06	08 to 12		
Typical reverse recovery time	t_{rr}	$T_J = 25^\circ C$, $I_F = 0.5A$, $I_R = 1.0A$, $I_{RR} = 250mA$ (RG#1 1CKT)		250	ns
		$T_J = 25^\circ C$, $I_F = 1A$ to $V_R = 30V$, $-dI_F/dt = 100 A/\mu s$		60	
		$T_J = 25^\circ C$, $-dI_F/dt = 25 A/\mu s$, $I_{FM} = \pi \times \text{rated } I_{F(AV)}$		250	
Typical reverse recovered charge	Q_{rr}	$T_J = 25^\circ C$, $I_F = 1A$ to $V_R = 30V$, $-dI_F/dt = 100 A/\mu s$		85	nC
		$T_J = 25^\circ C$, $-dI_F/dt = 25 A/\mu s$, $I_{FM} = \pi \times \text{rated } I_{F(AV)}$		290	

FORWARD CONDUCTION					
PARAMETER	SYMBOL	TEST CONDITIONS		150FD(R)	UNIT
Maximum junction operating and storage temperature range	T_J, T_{stg}			-40 to 175	°C
Maximum thermal resistace, junction to case	R_{thJC}	DC operation		0.3	K/W
Maximum thermal resistance case to heatsink	R_{thCS}	Mounting surface, smooth, flat and greased		0.1	
Maximum allowable mounting torque (+0%, -20%)		Not lubricated threads		17	Nm
		Lubricated threads		14.5	
Approximate weight		Ceramic housing		100	g
		Glass-metal seal		95	
Case style		(JEDEC) see dimensions - link at the end of datasheet		DO-205AA (DO-8)	

△ R_{thJC} CONDUCTION

CONDUCTION ANGEL	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDUCTIONS	UNITS
180°	0.031	0.023	$T_J = T_J$ maximum	K/W
120°	0.038	0.040		
90°	0.048	0.053		
60°	0.071	0.075		
30°	0.120	0.121		

Note

- The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

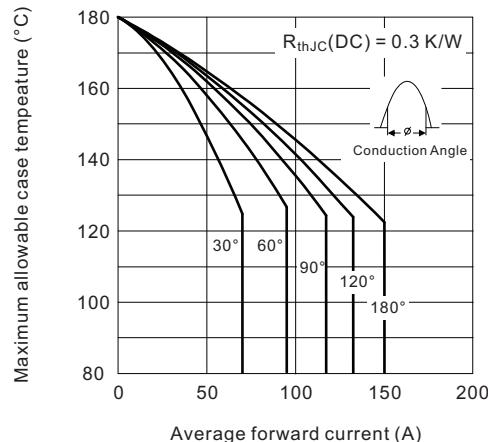
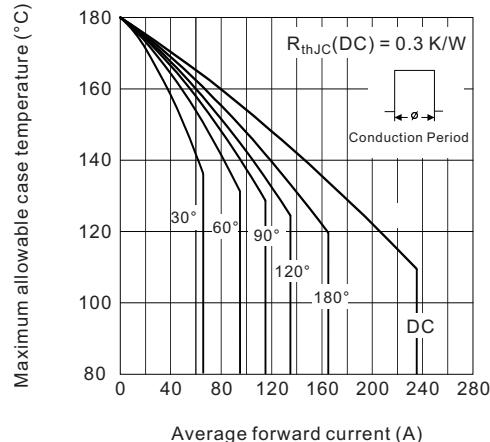
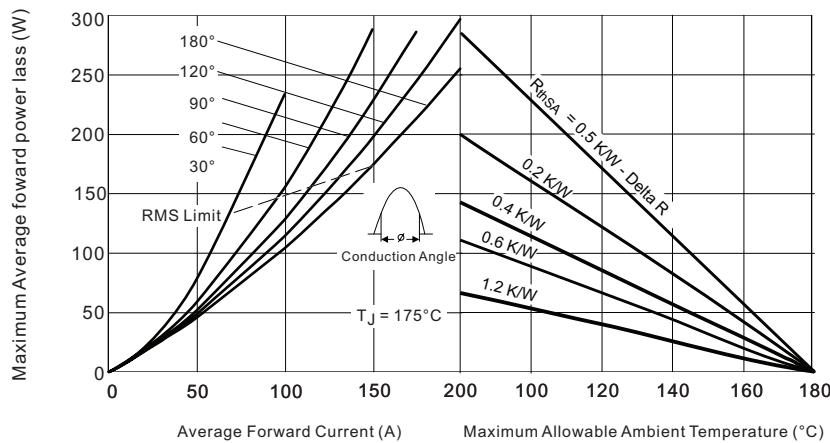
Fig.1 Current ratings characteristics

Fig.2 Current ratings characteristics

Fig.3 Forward power loss characteristics


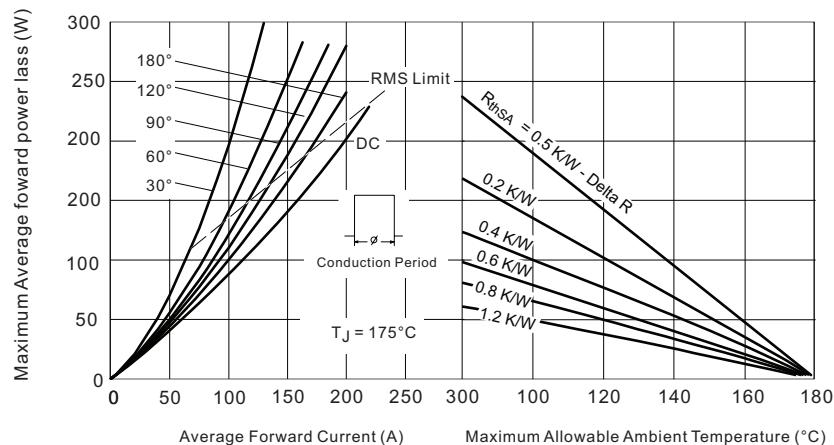
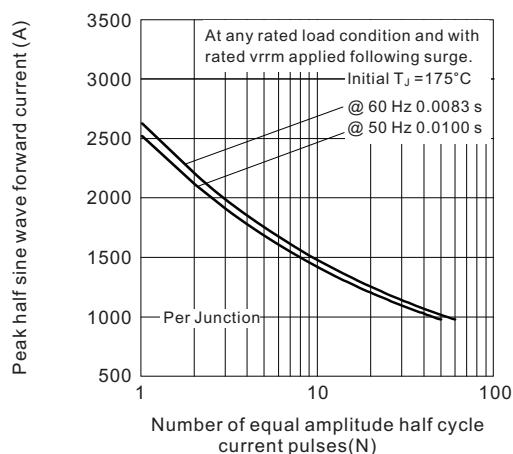
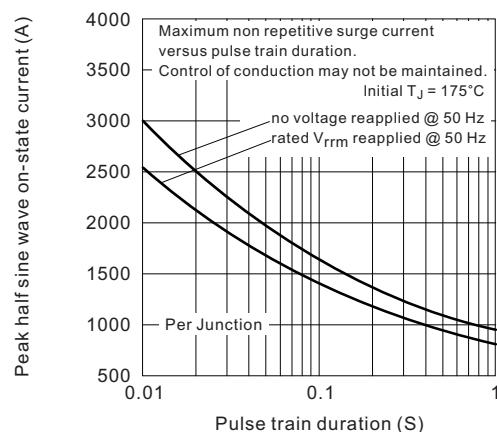
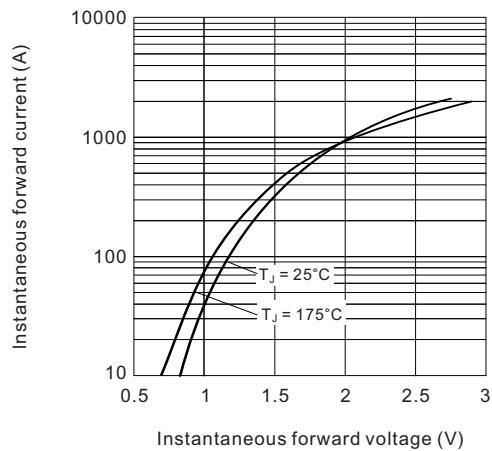
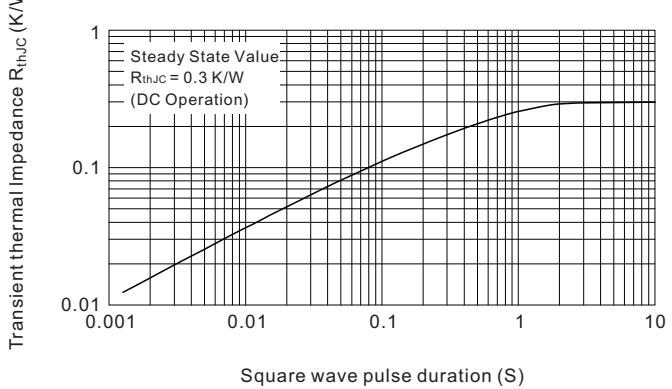
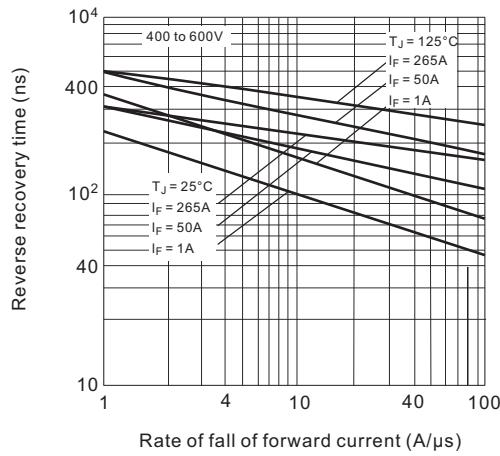
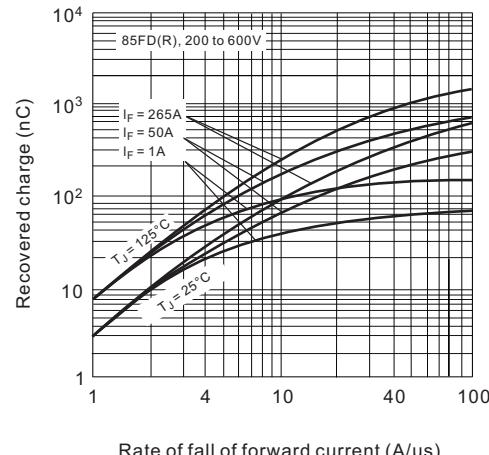
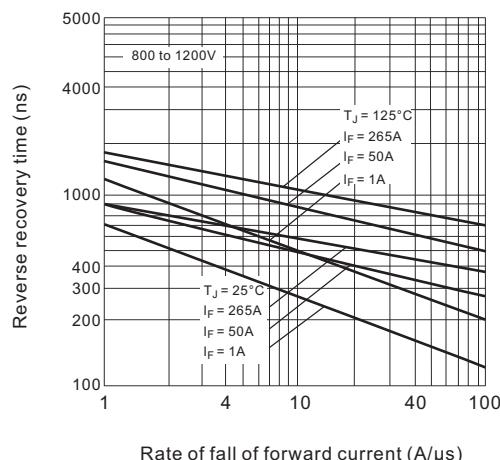
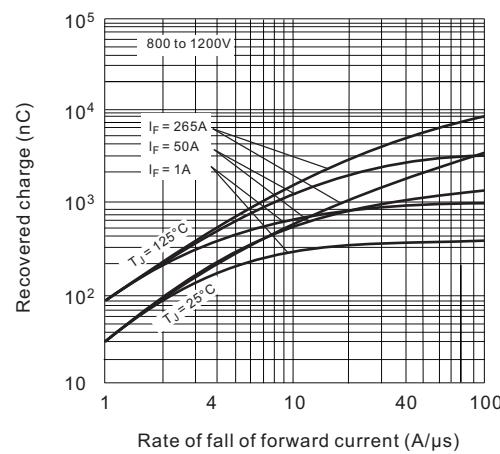
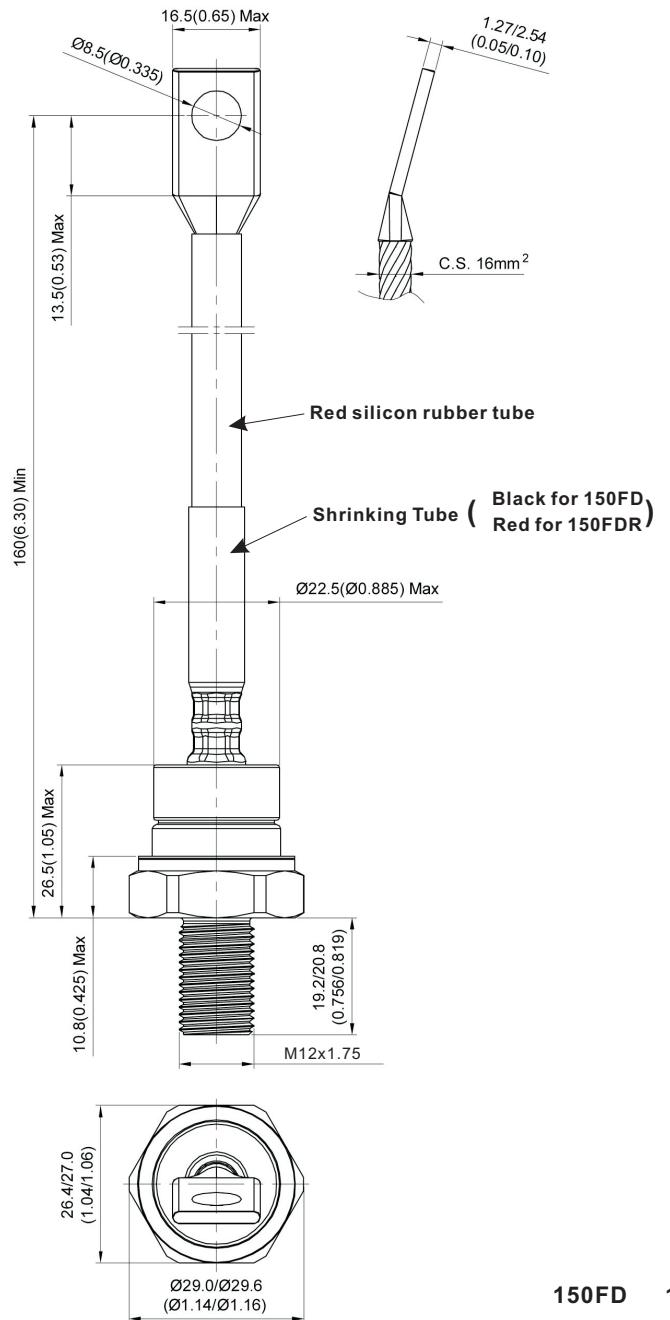
Fig.4 Forward power loss characteristics

Fig.5 Maximum non-repetitive surge current

Fig.6 Maximum non-repetitive surge current

Fig.7 Forward voltage drop characteristics

Fig.8 Thermal Impedance RthJC characteristic


Fig .9 Typical reverse recovery time vs. rate of fall of forward current.

Fig .10 Typical recovered charge vs. rate of fall of forward current.

Fig .11 Typical reverse recovery time vs. rate of fall of forward current.

Fig .12 Typical recovered charge vs. rate of fall of forward current.


ORDERING INFORMATION TABLE

Device code	150	FD	R	10	M	A
	1	2	3	4	5	6

- [1] - Current rating, 150 = 150A
- [2] - FD = Fast Recovery Diode
- [3] - None = Stud normal polarity (cathode to stud)
R = Stud reverse polarity (anode to stud)
- [4] - Voltage code × 100 = V_{RRM} (see Voltage Ratings table)
- [5] - DO-8, Ceramic housing type with M12x1.75 stud
and insulated tube
- [6] - trr Value, A=250 nS Max.,
B=500 nS Max.,

DO-205AA (DO-8), Ceramic housing


All dimensions in millimeters (inches)

